

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

23.04.2026

**WÜRTH
ELEKTRONIK**
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1		
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	227		2		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3		
		105	L2			
C-RS-FR4-ML-0.203mm-105+105-TG150-HF-...	50203085	203		4	A01	
		105	L3			
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	257		5		
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		6		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		7		
		105	L4			
C-RS-FR4-ML-0.203mm-105+105-TG150-HF-...	50203085	203		8	A02	B00
		105	L5			
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	257		9		
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		10		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		11		
		105	L6			
C-RS-FR4-ML-0.203mm-105+105-TG150-HF-...	50203085	203		12	A03	
		105	L7			
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	227		13		
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		14		
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	15		

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

2243 µm

Version 1.2.20.35

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